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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/816,269	03/31/2004	Robert P. Masleid	TRAN-P293	9824
7590 05/17/2006 WAGNER, MURABITO & HAO LLP Third Floor Two North Market Street San Jose, CA 95113			EXAMINER PHAM, LONG	
			ART UNIT 2814	PAPER NUMBER

DATE MAILED: 05/17/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/816,269

Applicant(s)

MASLEID ET AL.

Examiner

Long Pham

Art Unit

2814

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☒ Responsive to communication(s) filed on 03 March 2006.
- 2a) ☐ This action is **FINAL**. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1,2,6-12,16-22 and 26-33 is/are pending in the application.
- 4a) Of the above claim(s) _____ is/are withdrawn from consideration.
- 5) ☐ Claim(s) _____ is/are allowed.
- 6) ☒ Claim(s) 1,2,6-12,16-22 and 26-33 is/are rejected.
- 7) ☐ Claim(s) _____ is/are objected to.
- 8) ☐ Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on _____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
- Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
- Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☐ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☐ All b) ☐ Some * c) ☐ None of:
1. ☐ Certified copies of the priority documents have been received.
2. ☐ Certified copies of the priority documents have been received in Application No. _____.
3. ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).
- * See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- 1) ☐ Notice of References Cited (PTO-892)
- 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948)
- 3) ☐ Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____.
- 4) ☐ Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____.
- 5) ☐ Notice of Informal Patent Application (PTO-152)
- 6) ☐ Other: _____.

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

Claims 1-2, 6-12, 16-22, and 26-33 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takahashi et al. (US publication 2001/0024859).

With respect to claims 1 and 21, Takahashi et al. teach a semiconductor device having a surface, comprising (see all disclosed figures, specifically figs. 19(a)-19(b), 20(a)-20(b), and 49 and associated text):

A plurality of conductive sub-surface regions 22nb, 23nb, etc. of a first conductivity each formed beneath said surface, wherein said conductive sub-surface regions form a sub-surface structure and said sub-surface structure has a perimeter (fig. 49);

An isolation structure SGI formed within said perimeter of said sub-surface structure such that said isolation structure creates a gap or separation in said sub-surface structure; and

At least one metal structure L1 formed above said surface, wherein said metal structure spans or runs over said gap and is coupled to said sub-surface structure via a plurality of tap contacts CON1.

Further with respect to claims 1 and 21, Takahashi et al. teach the conductive sub-surface regions as claimed, it is capable of routing a body-bias voltage.

Art Unit: 2814

With respect to claim 11,

Takahashi et al. teach a semiconductor device having a surface, comprising (see all disclosed figures, specifically figs. 19(a)-19(b), 20(a)-20(b), and 49 and associated text):

A first plurality of conductive sub-surface regions 22nb,etc. of a first conductivity each formed beneath said surface, wherein said conductive sub-surface regions form a first sub-surface structure and said sub-surface structure has a perimeter (fig. 49);

A second plurality of conductive sub-surface regions 23nb of said first conductivity each formed beneath said surface, wherein said second plurality of conductive sub-surface regions form a second sub-surface structure;

An isolation structure SGI formed between said first sub-surface structure and said second sub-surface structure such that said isolation structure creates a gap or separation between said first sub-surface structure and said second sub-surface structure; and

At least one metal structure L1 formed above said surface, wherein said metal structure spans or runs over said gap and is coupled to said first sub-surface structure and said second sub-surface structure via a plurality of tap contacts CON1.

With respect to claim 12, Takahashi et al. further teach the first sub-surface structure is a first diagonal sub-surface mesh structure, and wherein said second sub-surface structure is a second diagonal sub-surface mesh structure. See figs. 19(a) and 20(a).

With respect to claims 2 and 22, Takahashi et al. further teach the sub-surface structure is a diagonal sub-surface mesh structure. See figs. 19(a) and 20(a).

With respect to claims 6, 7, 16, 17 26, and 27, Takahashi et al. further teach each conductive sub-surface region has an N-type or P-type doping. See fig. 49.

With respect to claims 8, 18, 28, Takahashi et al. further teach each conductive sub-surface region has a strip shape. See fig. 49.

With respect to claims 9, 19, 29, 30, and 31, Takahashi et al. appear to fail to teach the metal structure is metal or polysilicon or diffusion or silicide wire.

However, the connection between sub-surface regions by a metal or polysilicon or diffusion or silicide wire is well-known.

With respect to claims 10, 20, 32, Takahashi et al. further teach a plurality of second conductive sub-surface regions 23nb of said first conductivity each formed under each portion of said metal structure that overlaps said sub-surface structure, wherein each second conductive sub-surface region has a continuous sub-surface layer shape. See fig. 49.

With respect to claim 33, Takahashi et al. further teach the isolation structure divides the sub-surface into a first portion and a second portion. See fig. 49.

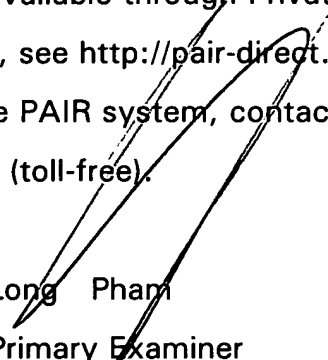
Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Long Pham whose telephone number is 571-272-1714. The examiner can normally be reached on Mon-Frid, 10am to 5pm.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 571-272-1705. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Art Unit: 2814

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).



Long Pham
Primary Examiner
Art Unit 2814

LP